

# 2-641605-2

### 2-641605-2 Information

	 2-641605-2 TE Connectivity AMP Connectors Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 28POS GOLD - For the pricing/inventory/lead time, please contact	
For Reference Only	us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

# **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



## 2-641605-2 Specifications

Manufacturer Part Number	2-641605-2
Manufacturer	TE Connectivity AMP Connectors
Category	Connectors, Interconnects
Category	Sockets for ICs, Transistors
Package	-
Series	- Diplomate DL
	DIP, 0.6" (15.24mm) Row Spacing
Type	
Number of Positions or Pins (Grid)	28 (2 x 14)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	30µin (0.76µm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Open Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Gold
Contact Finish Thickness - Post	30µin (0.76µm)
Contact Material - Post	Beryllium Copper
Housing Material	Thermoplastic, Glass Filled
Operating Temperature	-55°C ~ 125°C
	Report errors?

#### 2-641605-2 Guarantees



Quality Guarantees

We provide 90 days warranty. \* If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

#### Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.



If you have any question about 2-641605-2, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com